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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Details	
Product Status	Active
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	LINbus, SIO, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	25
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 5.5V
Data Converters	A/D 9x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f212l2sdfp-x6

Email: info@E-XFL.COM

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RENESAS

R8C/2K Group, R8C/2L Group RENESAS MCU

1. Overview

1.1 Features

The R8C/2K Group and R8C/2L Group of single-chip MCUs incorporates the R8C/Tiny Series CPU core, employing sophisticated instructions for a high level of efficiency. With 1 Mbyte of address space, and it is capable of executing instructions at high speed. In addition, the CPU core boasts a multiplier for high-speed operation processing.

Power consumption is low, and the supported operating modes allow additional power control. These MCUs also use an anti-noise configuration to reduce emissions of electromagnetic noise and are designed to withstand EMI. Integration of many peripheral functions, including multifunction timer and serial interface, reduces the number of system components.

Furthermore, the R8C/2L Group has on-chip data flash (1 KB \times 2 blocks).

The difference between the R8C/2K Group and R8C/2L Group is only the presence or absence of data flash. Their peripheral functions are the same.

1.1.1 Applications

Electronic household appliances, office equipment, audio equipment, consumer equipment, etc.



1.1.2 Specifications

Tables 1.1 and 1.2 outlines the Specifications for R8C/2K Group and Tables 1.3 and 1.4 outlines the Specifications for R8C/2L Group.

Item	Function	Specification
CPU	Central processing	R8C/Tiny series core
	unit	Number of fundamental instructions: 89
		Minimum instruction execution time:
		50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V)
		100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
		200 ns (f(XIN) = 5 MHz, VCC = 2.2 to 5.5 V)
		• Multiplier: 16 bits \times 16 bits \rightarrow 32 bits
		• Multiply-accumulate instruction: 16 bits \times 16 bits $+$ 32 bits \rightarrow 32 bits
		Operation mode: Single-chip mode (address space: 1 Mbyte)
Memory	ROM, RAM	Refer to Table 1.5 Product List for R8C/2K Group.
Power Supply	Voltage detection	Power-on reset
Voltage	circuit	Voltage detection 3
Detection	Circuit	· Voltage detection 3
I/O Ports	Programmable I/O	Input-only: 3 pins
1/01/01/3	ports	CMOS I/O ports: 25, selectable pull-up resistor
	pons	 High current drive ports: 8
Clock	Clask gaparation	
CIOCK	Clock generation	2 circuits: XIN clock oscillation circuit (with on-chip feedback resistor), On-chip oscillator (high-speed, low-speed)
	circuits	
		(high-speed on-chip oscillator has a frequency adjustment function)
		Oscillation stop detection: XIN clock oscillation stop detection function
		• Frequency divider circuit: Dividing selectable 1, 2, 4, 8, and 16
		Low power consumption modes:
		Standard operating mode (high-speed clock, high-speed on-chip oscillator,
		low-speed on-chip oscillator), wait mode, stop mode
Interrupts		 External: 4 sources, Internal: 15 sources, Software: 4 sources
		Priority levels: 7 levels
Watchdog Tim		15 bits \times 1 (with prescaler), reset start selectable
Timer	Timer RA	8 bits x 1 (with 8-bit prescaler)
		Timer mode (period timer), pulse output mode (output level inverted every
		period), event counter mode, pulse width measurement mode, pulse period
		measurement mode
	Timer RB	8 bits × 1 (with 8-bit prescaler)
		Timer mode (period timer), programmable waveform generation mode (PWM
		output), programmable one-shot generation mode, programmable wait one-
		shot generation mode
	Timer RC	16 bits × 1 (with 4 capture/compare registers)
		Timer mode (input capture function, output compare function), PWM mode
		(output 3 pins), PWM2 mode (PWM output pin)
	Timer RD	16 bits × 2 (with 4 capture/compare registers)
		Timer mode (input capture function, output compare function), PWM mode
		(output 6 pins), reset synchronous PWM mode (output three-phase
		waveforms (6 pins), sawtooth wave modulation), complementary PWM mode
		(output three-phase waveforms (6 pins), triangular wave modulation), PWM3
		mode (PWM output 2 pins with fixed period)

 Table 1.1
 Specifications for R8C/2K Group (1)

RENESAS

Item	Function	Specification		
Serial	UART0, UART2	Clock synchronous serial I/O/UART × 2		
Interface				
LIN Module		Hardware LIN: 1 (timer RA, UART0)		
A/D Converter		10-bit resolution × 9 channels, includes sample and hold function		
Flash Memory		 Programming and erasure voltage: VCC = 2.7 to 5.5 V 		
		 Programming and erasure endurance: 10,000 times (data flash) 		
		1,000 times (program ROM)		
		 Program security: ROM code protect, ID code check 		
		 Debug functions: On-chip debug, on-board flash rewrite function 		
Operating Free	luency/Supply	f(XIN) = 20 MHz (VCC = 3.0 to 5.5 V)		
Voltage		f(XIN) = 10 MHz (VCC = 2.7 to 5.5 V) f(XIN) = 5 MHz (VCC = 2.2 to 5.5 V) (VCC = 2.7 to 5.5 V for A/D converter only)		
Current consur	nption	Typ. 10 mA (VCC = 5.0 V, f(XIN) = 20 MHz)		
		Typ. 6 mA (VCC = 3.0 V, $f(XIN) = 10 \text{ MHz})'$		
		Typ. 23 μ A (VCC = 3.0 V, wait mode, low-speed on-chip oscillator used) Typ. 0.7 μ A (VCC = 3.0 V, stop mode)		
Operating Amb	ient Temperature	-20 to 85°C (N version)		
		-40 to 85°C (D version) ⁽¹⁾		
		-20 to 105°C (Y version) ⁽²⁾		
Package		32-pin LQFP		
		Package code: PLQP0032GB-A (previous code: 32P6U-A)		

 Table 1.4
 Specifications for R8C/2L Group (2)

NOTES:

1. Specify the D version if D version functions are to be used.

2. Please contact Renesas Technology sales offices for the Y version.



Current of Dec. 2007

1.2 Product List

Table 1.5 lists the Product List for R8C/2K Group, Figure 1.1 shows a Part Number, Memory Size, and Package of R8C/2K Group, Table 1.6 lists the Product List for R8C/2L Group, and Figure 1.2 shows a Part Number, Memory Size, and Package of R8C/2L Group.

Part No.	ROM Capacity	RAM Capacity	Package Type	Remarks
R5F212K2SNFP	8 Kbytes	1 Kbyte	PLQP0032GB-A	N version
R5F212K4SNFP	16 Kbytes	1.5 Kbytes	PLQP0032GB-A	
R5F212K2SDFP	8 Kbytes	1 Kbyte	PLQP0032GB-A	D version
R5F212K4SDFP	16 Kbytes	1.5 Kbytes	PLQP0032GB-A	
R5F212K2SNXXXFP (D)	8 Kbytes	1 Kbyte	PLQP0032GB-A	N version
R5F212K4SNXXXFP (D)	16 Kbytes	1.5 Kbytes	PLQP0032GB-A	Factory programming product ⁽¹⁾
R5F212K2SDXXXFP (D)	8 Kbytes	1 Kbyte	PLQP0032GB-A	D version
R5F212K4SDXXXFP (D)	16 Kbytes	1.5 Kbytes	PLQP0032GB-A	Factory programming product ⁽¹⁾

Table 1.5 Product List for R8C/2K Group

(D): Under development

NOTE:

1. The user ROM is programmed before shipment.

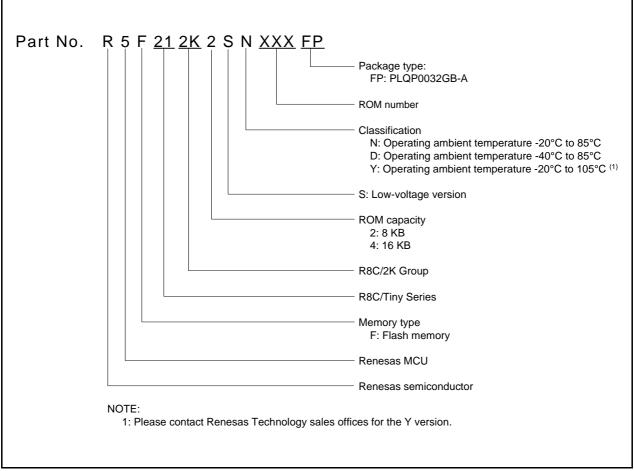
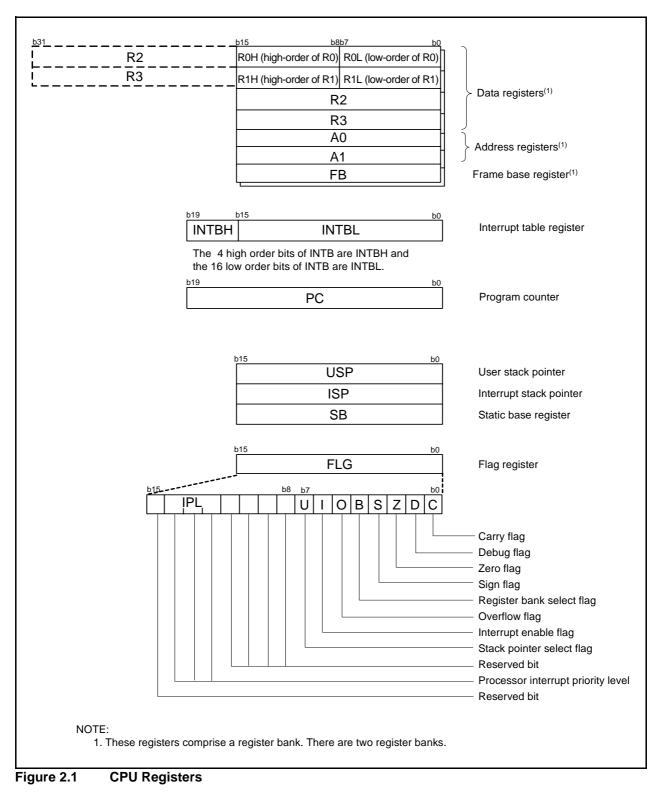


Figure 1.1 Part Number, Memory Size, and Package of R8C/2K Group



2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.



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2.1 Data Registers (R0, R1, R2, and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3. R0 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R1H and R1L are analogous to R0H and R0L. R2 can be combined with R0 and used as a 32-bit data register (R2R0). R3R1 is analogous to R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. It is also used for transfer, arithmetic, and logic operations. A1 is analogous to A0. A1 can be combined with A0 and as a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register that indicates the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC is 20 bits wide and indicates the address of the next instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP, and ISP, are each 16 bits wide. The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is an 11-bit register indicating the CPU state.

2.8.1 Carry Flag (C)

The C flag retains carry, borrow, or shift-out bits that have been generated by the arithmetic and logic unit.

2.8.2 Debug Flag (D)

The D flag is for debugging only. Set it to 0.

2.8.3 Zero Flag (Z)

The Z flag is set to 1 when an arithmetic operation results in 0; otherwise to 0.

2.8.4 Sign Flag (S)

The S flag is set to 1 when an arithmetic operation results in a negative value; otherwise to 0.

2.8.5 Register Bank Select Flag (B)

Register bank 0 is selected when the B flag is 0. Register bank 1 is selected when this flag is set to 1.

2.8.6 Overflow Flag (O)

The O flag is set to 1 when an operation results in an overflow; otherwise to 0.

Special Function Registers (SFRs) 4.

An SFR (special function register) is a control register for a peripheral function. Tables 4.1 to 4.7 list the special function registers.

Address	Register	Symbol	After reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	01101000b
0007h	System Clock Control Register 1	CM1	0010000b
0008h			
0009h			
000Ah	Protect Register	PRCR	00h
000Bh			
000Ch	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDC	00X11111b
0010h	Address Match Interrupt Register 0	RMAD0	00h
0011h			00h
0012h			00h
0013h	Address Match Interrupt Enable Register	AIER	00h
0014h	Address Match Interrupt Register 1	RMAD1	00h
0015h			00h
0016h			00h
0017h			
0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protection Mode Register	CSPR	00h 10000000b ⁽⁶⁾
001Dh			
001Eh			
001Fh			
0020h			
0021h			
0022h			
0023h	High-Speed On-Chip Oscillator Control Register 0	FRA0	00h
0024h	High-Speed On-Chip Oscillator Control Register 1	FRA1	When shipping
0025h	High-Speed On-Chip Oscillator Control Register 2	FRA2	00h
0026h			
0027h			
0028h			
0029h			
002Ah			
002Bh	High-Speed On-Chip Oscillator Control Register 6	FRA6	When Shipping
002Ch	High-Speed On-Chip Oscillator Control Register 7	FRA7	When Shipping
0030h	1		
0031h	Valtage Detection Desigter (2)		00001000b

SFR Information (1)⁽¹⁾ Table 4.1

0030h			
0031h	Voltage Detection Register 1 ⁽²⁾	VCA1	00001000b
0032h	Voltage Detection Register 2 ⁽²⁾	VCA2	00h ⁽³⁾
			0010000b ⁽⁴⁾
0033h			
0034h			
0035h			
0036h	Voltage Monitor 1 Circuit Control Register ⁽⁵⁾	VW1C	00001000b
0037h	Voltage Monitor 2 Circuit Control Register ⁽⁵⁾	VW2C	00h
0038h	Voltage Monitor 0 Circuit Control Register ⁽²⁾	VW0C	0000X000b ⁽³⁾
			0100X001b ⁽⁴⁾
0039h			
003Ah			

003Fh

X: Undefined NOTES:

The blank regions are reserved. Do not access locations in these regions. Software reset, watchdog timer reset, voltage monitor 1 reset, or voltage monitor 2 reset do not affect this register. The LVD0ON bit in the OFS register is set to 1 and hardware reset. 1. 2.

3.

Power-on reset, voltage monitor 0 reset, or the LVD00N bit in the OFS register is set to 0 and hardware reset. Software reset, watchdog timer reset, voltage monitor 1 reset, or voltage monitor 2 reset do not affect b2 and b3. The CSPROINI bit in the OFS register is set to 0.

4. 5.

6.



Address	Register	Symbol	After reset
0080h	register	Gymbol	7110110301
0081h			
0082h			
0083h			
0084h			
0085h			
0086h			
0087h			
0088h			
0089h			
008Ah			
008Bh			
008Ch			
008Dh			
008Eh			
008Fh			
0090h			
0091h			
0092h			
0093h			
0094h			
0095h			
0096h			
0097h			
0098h			
0099h			
009Ah			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh			
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00A1h	UARTO Bit Rate Register	U0BRG	XXh
00A1h 00A2h	UARTO Bit Rate Register UARTO Transmit Buffer Register	U0BRG U0TB	XXh
00A3h	UARTO Bit Rate Register UARTO Transmit Buffer Register	U0TB	XXh XXh
00A3h 00A4h	UART0 Transmit/Receive Control Register 0	U0TB U0C0	XXh XXh 00001000b
00A3h 00A4h 00A5h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b
00A3h 00A4h 00A5h 00A6h	UART0 Transmit/Receive Control Register 0	U0TB U0C0	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A8h 00A9h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A8h 00A9h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A8h 00A9h 00AAh 00ABh 00ACh 00ADh	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A9h 00A8h 00ABh 00ACh 00ADh 00AEh	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A9h 00A8h 00ABh 00ACh 00ADh 00AEh	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A9h 00A8h 00ABh 00ACh 00ADh 00AEh	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A4h 00AAh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A8h 00A8h 00AAh 00ABh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00AFh 00B0h 00B1h 00B2h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A8h 00AAh 00AAh 00AAh 00ACh 00ACh 00ACh 00ACh 00ACh 00AFh 00AFh 00B1h 00B2h 00B3h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A8h 00A9h 00AAh 00ABh 00ACh 00ADh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00B2h 00B2h 00B3h 00B4h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A9h 00A9h 00ABh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00B4h 00B3h 00B4h 00B5h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00B4h 00B4h 00B5h 00B6h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A8h 00A8h 00A8h 00A8h 00A8h 00A8h 00A8h 00A8h 00A8h 00B7h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A3h 00A4h 00AAh 00AAh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00AFh 00B4h 00B3h 00B3h 00B3h 00B5h 00B7h 00B7h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A8h 00AAh 00AAh 00AAh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00ACh 00B4h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00B9h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A9h 00A9h 00A9h 00A2h 00A2h 00A2h 00A2h 00A2h 00B3h 00B3h 00B3h 00B3h 00B3h 00B3h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A9h 00A9h 00A8h 00A2h 00A2h 00A2h 00A2h 00A2h 00B3h 00B3h 00B3h 00B3h 00B3h 00B3h 00B3h 00B3h 00B3h 00B3h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A9h 00A9h 00A8h 00A2h 00A2h 00A2h 00A2h 00A2h 00B4h 00B2h 00B3h 00B4h 00B3h 00B3h 00B3h 00B3h 00B3h 00B3h 00B3h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A8h 00AAh 00A2h 00A2h 00A2h 00A2h 00A2h 00A2h 00B4h 00B4h 00B3h 00B3h 00B6h 00B6h 00B6h 00B6h 00B3h 00B6h 00B3h 00B6h 00B6h 00B6h 00B6h 00B6h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh
00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00A9h 00A9h 00A9h 00A9h 00A9h 00A2h 00A2h 00A2h 00A7h 00A7h 00A9h 00B4h 00B3h 00B4h 00B3h 00B4h 00B3h 00B3h 00B3h 00B3h 00B3h 00B3h	UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0TB U0C0 U0C1	XXh XXh 00001000b 00000010b XXh

SFR Information (3)⁽¹⁾ Table 4.3

X: Undefined NOTE: 1. The blank regions are reserved. Do not access locations in these regions.

Address	Register	Symbol	After reset
00C0h	A/D Register	AD	XXh
00C1h		, (2	XXh
00C2h			AAII
00C3h			
00C4h			
00C5h			
00C6h			
00C7h			
00C8h			
00C9h			
00CAh			
00CBh			
00CCh			
00CDh			
00CEh			
00CFh			
00D0h			
00D1h			
00D2h			1
00D3h			1
00D4h	A/D Control Register 2	ADCON2	00h
00D411			1
00D5h	A/D Control Register 0	ADCON0	00h
	A/D Control Desister 1		
00D7h	A/D Control Register 1	ADCON1	00h
00D8h			
00D9h			
00DAh			
00DBh			
00DCh			
00DDh			
00DEh			
00DFh		-	
00E0h	Dort DO Dorigtor	D0	XXh
	Port PO Register	P0	
00E1h	Port P1 Register	P1	XXh
00E2h	Port P0 Direction Register	PD0	00h
00E3h	Port P1 Direction Register	PD1	00h
00E4h	Port P2 Register	P2	XXh
00E5h	Port P3 Register	P3	XXh
00E6h	Port P2 Direction Register	PD2	00h
00E7h	Port P3 Direction Register	PD3	00h
00E8h	Port P4 Register	P4	XXh
00E9h		14	AAII
	Dest D4 Direction Destates	DD 4	0.01
00EAh	Port P4 Direction Register	PD4	00h
00EBh			1
00ECh			
00EDh			
00EEh			
00EFh			1
00F0h			1
00F1h		1	1
00F2h		+	1
00F2h			1
	 Dent D0 Drive Organity Organization	DODDD	0.01
00F4h	Port P2 Drive Capacity Control Register	P2DRR	00h
00F5h	Pin Select Register 1	PINSR1	XXh
00F6h	Pin Select Register 2	PINSR2	XXh
00F7h	Pin Select Register 3	PINSR3	XXh
00F8h	Port Mode Register	PMR	00h
00F9h	External Input Enable Register	INTEN	00h
00FAh	INT Input Filter Select Register	INTE	00h
00FBh	Key Input Enable Register	KIEN	00h
00FCh		PUR0	00h
	Pull-Up Control Register 0		
00FDh	Pull-Up Control Register 1	PUR1	XX000000b
00FEh			
00FFh			
Villadofinad			

SFR Information (4)⁽¹⁾ Table 4.4

X: Undefined NOTE: 1. The blank regions are reserved. Do not access locations in these regions.

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Cumbal	Parameter	Conditions		Unit		
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
_	Program/erase endurance ⁽²⁾	R8C/2K Group	100 ⁽³⁾	-	-	times
		R8C/2L Group	1,000(3)	-	-	times
-	Byte program time		-	50	400	μS
_	Block erase time		-	0.4	9	S
td(SR-SUS)	Time delay from suspend request until suspend		-	-	97+CPU clock × 6 cycles	μS
-	Interval from erase start/restart until following suspend request		650	-	_	μS
-	Interval from program start/restart until following suspend request		0	-	_	ns
_	Time from suspend until program/erase restart		-	-	3+CPU clock × 4 cycles	μS
-	Program, erase voltage		2.7	-	5.5	V
-	Read voltage		2.2	_	5.5	V
_	Program, erase temperature		0	-	60	°C
-	Data hold time ⁽⁷⁾	Ambient temperature = 55°C	20	-	-	year

Table 5.4 Flash Memory (Program ROM) Electrical Characteristics

NOTES: 1. Vcc = 2.7 to 5.5 V at Topr = 0 to 60°C, unless otherwise specified.

2. Definition of programming/erasure endurance The programming and erasure endurance is defined on a per-block basis. If the programming and erasure endurance is n (n = 100 or 10,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.

However, the same address must not be programmed more than once per erase operation (overwriting prohibited).

3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).

- 4. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erase count of each block and limit the number of erase operations to a certain number.
- 5. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
- 6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
- 7. The data hold time includes time that the power supply is off or the clock is not supplied.

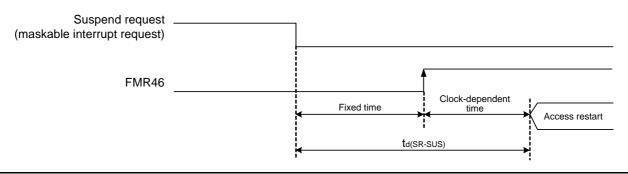


Figure 5.2 Time delay until Suspend

Table 5.6 Voltage Detection 0 Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
Symbol	Faiallielei	Condition	Min.	Тур.	Max.	Unit
Vdet0	Voltage detection level		2.2	2.3	2.4	V
-	Voltage detection circuit self power consumption	VCA25 = 1, Vcc = 5.0 V	-	0.9	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽²⁾		-	-	300	μS
Vccmin	MCU operating voltage minimum value		2.2	_	_	V

NOTES:

1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version).

2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0.

Table 5.7 Voltage Detection 1 Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Symbol	Falanelei	Condition	Min.	Тур.	Max.	Offic
Vdet1	Voltage detection level ⁽⁴⁾		2.70	2.85	3.00	V
-	Voltage monitor 1 interrupt request generation time ⁽²⁾		-	40	-	μS
-	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	-	0.6	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		-	-	100	μS

NOTES:

1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version).

2. Time until the voltage monitor 1 interrupt request is generated after the voltage passes Vdet1.

3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.

4. This parameter shows the voltage detection level when the power supply drops. The voltage detection level when the power supply rises is higher than the voltage detection level when the power supply drops by approximately 0.1 V.

Table 5.8 Voltage Detection 2 Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
Symbol	Falanetei	Condition	Min.	Тур.	Max.	Offic
Vdet2	Voltage detection level		3.3	3.6	3.9	V
-	Voltage monitor 2 interrupt request generation time ⁽²⁾		-	40	-	μS
-	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0 V	-	0.6	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		-	-	100	μS

NOTES:

1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version).

2. Time until the voltage monitor 2 interrupt request is generated after the voltage passes Vdet2.

3. Necessary time until the voltage detection circuit operates after setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.



Symbol	Parameter	Condition		Standard		
Symbol		Condition	Min.	Тур.	Max.	Unit
fOCO40M	High-speed on-chip oscillator frequency	Vcc = 2.7 V to 5.5 V	39.2	40	40.8	MHz
	temperature • supply voltage dependence	$-20^{\circ}C \leq T_{opr} \leq 85^{\circ}C^{(2)}$				
		Vcc = 2.7 V to 5.5 V	39.0	40	41.0	MHz
		$-40^\circ C \leq T_{opr} \leq 85^\circ C^{(2)}$				
		Vcc = 2.2 V to 5.5 V	35.2	40	44.8	MHz
		$-20^{\circ}C \leq T_{opr} \leq 85^{\circ}C^{(3)}$				
		Vcc = 2.2 V to 5.5 V	34.0	40	46.0	MHz
		$-40^\circ C \leq T_{opr} \leq 85^\circ C^{(3)}$				
	High-speed on-chip oscillator frequency when	Vcc = 5.0 V, Topr = 25°C	-	36.864	-	MHz
	correction value in FRA7 register is written to	Vcc = 2.7 V to 5.5 V	-3%	-	3%	%
	FRA1 register ⁽⁴⁾	$-20^{\circ}C \le T_{opr} \le 85^{\circ}C$				
-	Value in FRA1 register after reset		08h	-	F7h	-
_	Oscillation frequency adjustment unit of high- speed on-chip oscillator	Adjust FRA1 register (value after reset) to -1	-	+0.3	_	MHz
-	Oscillation stability time	Vcc = 5.0 V, Topr = 25°C	-	10	100	μs
-	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	-	550	-	μΑ

Table 5.10 High-speed On-Chip Oscillator Circuit Electrical Characteristics

NOTES:

1. Vcc = 2.2 to 5.5 V, $T_{opr} = -20$ to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified. 2. These standard values show when the FRA1 register value after reset is assumed.

3. These standard values show when the corrected value of the FRA6 register is written to the FRA1 register.

4. This enables the setting errors of bit rates such as 9600 bps and 38400 bps to be 0% when the serial interface is used in UART mode.

Table 5.11 Low-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
		Condition	Min.	Тур.	Max.	Unit
fOCO-S	Low-speed on-chip oscillator frequency		30	125	250	kHz
-	Oscillation stability time		-	10	100	μS
-	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	-	15	-	μA

NOTE:

1. Vcc = 2.2 to 5.5 V, Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

Table 5.12 **Power Supply Circuit Timing Characteristics**

Symbol	Parameter	Condition		Unit		
		Condition	Min.	Тур.	Max.	Offic
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	-	2000	μS
td(R-S)	STOP exit time ⁽³⁾		1	_	150	μS

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NOTES:

The measurement condition is Vcc = 2.2 to 5.5 V and Topr = 25°C.
 Waiting time until the internal power supply generation circuit stabilizes during power-on.

3. Time until system clock supply starts after the interrupt is acknowledged to exit stop mode.

Symbol	Parameter		Condition		Standard			Unit
Symbol	Pa	lameter	Conduit	חכ	Min.	Тур.	Max.	Unit
Vон	Output "H"	Except P2_0 to P2_7,	Iон = -5 mA		Vcc - 2.0	-	Vcc	V
	voltage	XOUT	Іон = –200 μА		Vcc - 0.5	-	Vcc	V
		P2_0 to P2_7	Drive capacity HIGH	Iон = -20 mA	Vcc - 2.0	-	Vcc	V
			Drive capacity LOW	Iон = -5 mA	Vcc - 2.0	-	Vcc	V
		XOUT	Drive capacity HIGH	Iон = -1 mA	Vcc - 2.0	-	Vcc	V
			Drive capacity LOW	Іон = -500 μА	Vcc - 2.0	-	Vcc	V
Vol	Output "L" voltage	Except P2_0 to P2_7,	IOL = 5 mA	•	-	-	2.0	V
	XOUT	Ιοι = 200 μΑ		-	-	0.45	V	
		P2_0 to P2_7	Drive capacity HIGH	IoL = 20 mA	-	-	2.0	V
		Drive capacity LOW	IoL = 5 mA	-	-	2.0	V	
		XOUT	Drive capacity HIGH	IoL = 1 mA	-	-	2.0	V
			Drive capacity LOW	IoL = 500 μA	-	-	2.0	V
Vt+-Vt-	Hysteresis	INT0, INT1, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD2, CLK0, CLK2			0.1	0.5	_	V
		RESET			0.1	1.0	-	V
Ін	Input "H" current	I	VI = 5 V, Vcc = 5 V		-	-	5.0	μA
lı∟	Input "L" current		VI = 0 V, Vcc = 5 V		-	-	-5.0	μΑ
Rpullup	Pull-up resistance		VI = 0 V, Vcc = 5 V		30	50	167	kΩ
RfXIN	Feedback resistance	XIN			-	1.0	-	MΩ
Vram	RAM hold voltage		During stop mode		1.8	-	-	V

Table 5.13 Electrical Characteristics (1) [Vcc = 5 V]

NOTE:

1. Vcc = 4.2 to 5.5 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), f(XIN) = 20 MHz, unless otherwise specified.

Table 5.15Electrical Characteristics (3) [Vcc = 5 V]
(Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Symbol Parameter Conditi	Condition		Standard	ł	Unit	
Symbol	Falametei		Condition		Min. Typ. Max		Onit
Icc	Power supply current (Vcc = 3.3 to 5.5 V) Single-chip mode, output pins are open, other pins	Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	1	25	75	μΑ
	are Vss	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	23	60	μΑ	
		Stop mode	XIN clock off, $T_{opr} = 25^{\circ}C$ High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	-	0.8	3.0	μΑ
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	_	1.2	-	μΑ

Symbol	Parameter		Cond	lition	S	tandard		Unit
Symbol	Pala	inelei	Cond	illion	Min.	Тур.	Max.	Unit
Vон	Output "H" voltage	Except P2_0 to P2_7, XOUT	Iон = -1 mA		Vcc - 0.5	_	Vcc	V
		P2_0 to P2_7	Drive capacity HIGH	Iон = -5 mA	Vcc - 0.5	-	Vcc	V
			Drive capacity LOW	Iон = -1 mA	Vcc - 0.5	-	Vcc	V
		XOUT	Drive capacity HIGH	Iон = -0.1 mA	Vcc - 0.5	-	Vcc	V
			Drive capacity LOW	Іон = –50 μА	Vcc - 0.5	_	Vcc	V
VoL Output "L" voltage	Except P2_0 to P2_7, XOUT	IoL = 1 mA	·	-	-	0.5	V	
		P2_0 to P2_7	Drive capacity HIGH	IOL = 5 mA	-	-	0.5	V
			Drive capacity LOW	IOL = 1 mA	-	-	0.5	V
		XOUT	Drive capacity HIGH	IOL = 0.1 mA	-	-	0.5	V
			Drive capacity LOW	IOL = 50 μA	-	-	0.5	V
VT+-VT-	Hysteresis	INT0, INT1, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD2, CLK0, CLK2			0.1	0.3	-	V
		RESET			0.1	0.4	-	V
Ін	Input "H" current		VI = 3 V, Vcc = 3	V	-	_	4.0	μA
lı∟	Input "L" current		VI = 0 V, Vcc = 3	V	-	-	-4.0	μA
Rpullup	Pull-up resistance		VI = 0 V, Vcc = 3	V	66	160	500	kΩ
RfXIN	Feedback resistance	XIN			-	3.0	-	MΩ
Vram	RAM hold voltage		During stop mode	e	1.8	-	-	V

 Table 5.20
 Electrical Characteristics (1) [Vcc = 3 V]

NOTE:

1. Vcc =2.7 to 3.3 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), f(XIN) = 10 MHz, unless otherwise specified.

Timing requirements (Unless Otherwise Specified: Vcc = 3 V, Vss = 0 V at Topr = 25°C) [Vcc = 3 V]

Table 5.22 XIN Input

Symbol	Parameter		Standard		
			Max.	Unit	
tc(XIN)	XIN input cycle time	100	-	ns	
twh(xin)	XIN input "H" width	40	-	ns	
twl(XIN)	XIN input "L" width	40	-	ns	

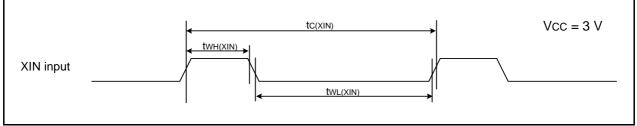


Figure 5.8 XIN Input Timing Diagram when Vcc = 3 V

Table 5.23 TRAIO Input

Symbol	Parameter	Stan	Unit	
		Min.	Max.	Unit
tc(TRAIO)	TRAIO input cycle time	300	=	ns
twh(traio)	TRAIO input "H" width	120	-	ns
twl(traio)	TRAIO input "L" width	120	-	ns

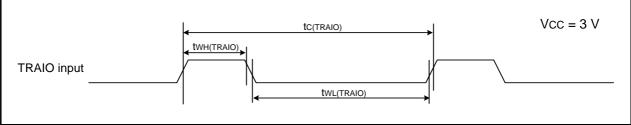


Figure 5.9 TRAIO Input Timing Diagram when Vcc = 3 V

Symbol	Parameter	Sta	Standard		
	Falanelei	Min.	Max.	Unit	
tc(CK)	CLKi input cycle time	300	-	ns	
tw(CKH)	CLKi input "H" width	150	-	ns	
tW(CKL)	CLKi Input "L" width	150	-	ns	
td(C-Q)	TXDi output delay time	-	80	ns	
th(C-Q)	TXDi hold time	0	-	ns	
tsu(D-C)	RXDi input setup time	70	-	ns	
th(C-D)	RXDi input hold time	90	-	ns	

i = 0, 2

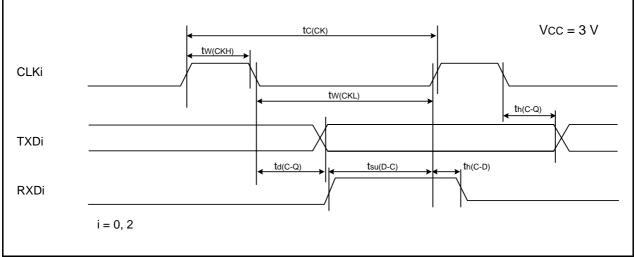




Table 5.25 External Interrupt INTi (i = 0, 1, 3) Input

Symbol	Parameter		Standard		
	Falameter	Min.	Max.	Unit	
tw(INH)	INTi input "H" width	380 ⁽¹⁾	-	ns	
tw(INL)	INTi input "L" width	380(2)	_	ns	

NOTES:

1. When selecting the digital filter by the INTi input filter select bit, use an INTi input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

When selecting the digital filter by the INTi input filter select bit, use an INTi input LOW width of either (1/digital filter clock frequency x 3) or the minimum value of standard, whichever is greater.

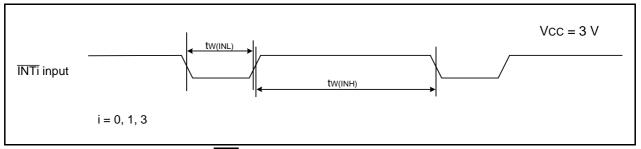


Figure 5.11 External Interrupt INTi Input Timing Diagram when Vcc = 3 V

Timing requirements (Unless Otherwise Specified: Vcc = 2.2 V, Vss = 0 V at Topr = 25°C) [Vcc = 2.2 V]

Table 5.28 XIN Input

Symbol	Parameter		Standard		
			Max.	Unit	
tc(XIN)	XIN input cycle time	200	-	ns	
twh(xin)	XIN input "H" width	90	-	ns	
twl(XIN)	XIN input "L" width	90	-	ns	

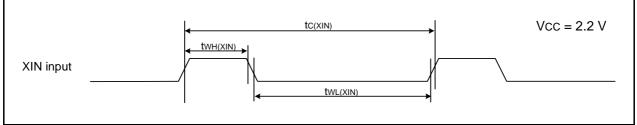


Figure 5.12 XIN Input Timing Diagram when Vcc = 2.2 V

Table 5.29 TRAIO Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	Unit
tc(TRAIO)	TRAIO input cycle time	500	-	ns
twh(traio)	TRAIO input "H" width	200	-	ns
twl(traio)	TRAIO input "L" width	200	-	ns

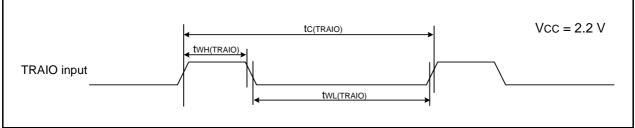


Figure 5.13 TRAIO Input Timing Diagram when Vcc = 2.2 V

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